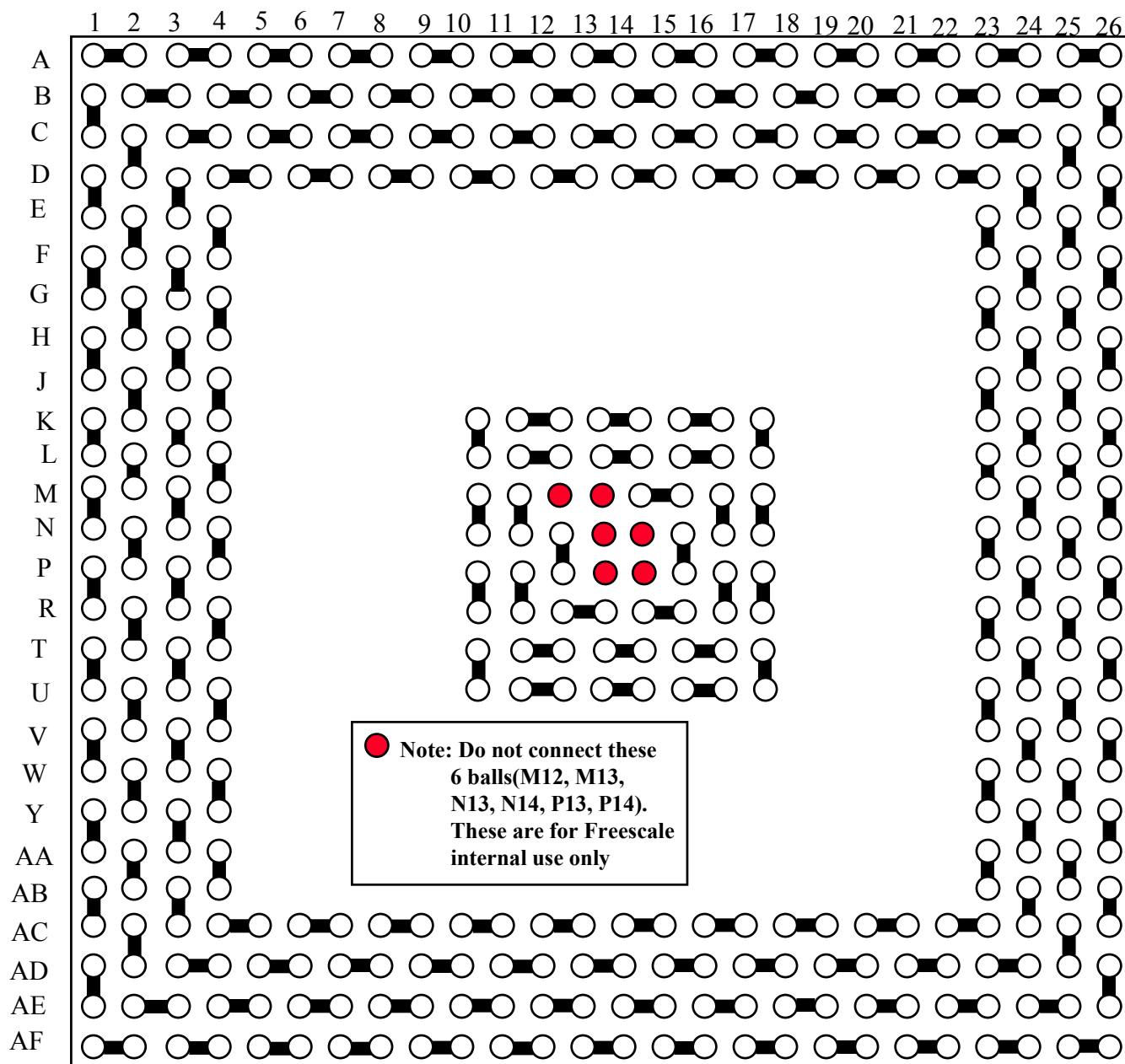




416 PIN TEPBGA Daisy Chain



Looking *through*
Package

- * 1.0 mm Pitch
- * 26x26 Array (4 Row Perim)
- * 64 Thermal Balls
- * 27x27 mm Body Size
- * 0.5 mm Package Pad
- * 0.6 mm Solder Ball Diam.

■ = BGA Package Trace

● Note: Do not connect these
6 balls(M12, M13,
N13, N14, P13, P14).
These are for Freescale
internal use only



416 PIN TEPBGA Daisy Chain – Suggested PCB Layout

